

**SPECIFICATION SHEET**

<b>SPECIFICATION SHEET NO.</b>	P1105- SMAFSS16FOS106
<b>DATE</b>	Nov. 05, 2022
<b>REVISION</b>	A1
<b>DESCRIPTION</b>	<p>SMD High Efficiency Rectifier, 2 Pads, SMAF series, SS16F Type</p> <p>Reverse Voltage 60V Max. Forward Current 1.0A Max.</p> <p>Operating Temp. Range -50°C ~+150°C</p> <p>Package in Tape/Reel, 3000pcs/Reel</p> <p>RoHS/RoHS III compliant</p>
<b>CUSTOMER</b>	
<b>CUSTOMER PART NUMBER</b>	
<b>CROSS REF. PART NUMBER</b>	
<b>ORIGINAL PART NUMBER</b>	MDD SS16F
<b>PART CODE</b>	SMAFSS16FOS106

**VENDOR APPROVE**

Issued/Checked/Approved



DATE: Nov. 05, 2022

**CUSTOMER APPROVE**

DATE:

11/5/2022

**SMD HIGH EFFICIENCY RECTIFIER SMAF SERIES**



**MAIN FEATURE**

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Low reverse leakage
- Built-in strain relief,
- High forward surge current capability
- Ultra fast switching for high efficiency
- High temperature soldering guaranteed: 250°C/ 10 seconds at terminals

**APPLICATION**

- For printed circuit board

**RFQ**

[Request For Quotation](#)

**PART CODE GUIDE**

SMAF	SS16F0	S	106
1	2	3	4

- 1) **SMAF**: SMD High Efficiency Rectifier, 2 Pads, SMAF series
- 2) **SS16F0**: Type code for original part number SS16F
- 3) **S**: Package code, Tape/reel, 3000pcs/reel.
- 4) **106**: Specification code for Reverse Voltage 60V Max. Forward Current 1.0A Max.

**MORE ITEMS AVAILABLE**

SMAFSS12F0S102	SMAFSS13F0S103	SMAFSS14F0S104	SMAFSS15F0S105	<b>SMAFSS16F0S106</b>
SMAFSS18F0S108	SMAFSS110F0S110	SMAFSS1150S115	SMAFSS1200S120	
SMAFSS22F0S202	SMAFSS23F0S203	SMAFSS24F0S204	SMAFSS25F0S205	SMAFSS26F0S206
SMAFSS28F0S208	SMAFSS210F0S210	SMAFSS2150S215	SMAFSS2200S220	
SMAFSS32F0S302	SMAFSS33F0S303	SMAFSS34F0S304	SMAFSS35F0S305	SMAFSS36F0S306
SMAFSS38F0S308	SMAFSS310F0S310	SMAFSS3150S315	SMAFSS3200S320	
SMAFSS52F0S502	SMAFSS53F0S503	SMAFSS54F0S504	SMAFSS55F0S505	SMAFSS56F0S506
SMAFSS58F0S508	SMAFSS510F0S510	SMAFSS5150S515	SMAFSS5200S520	

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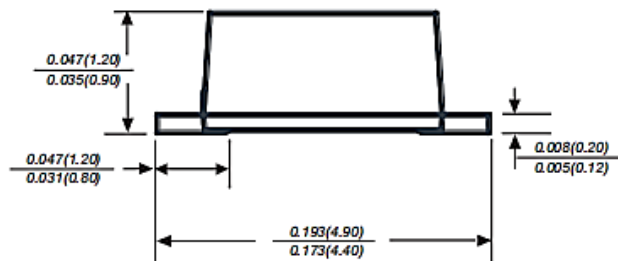
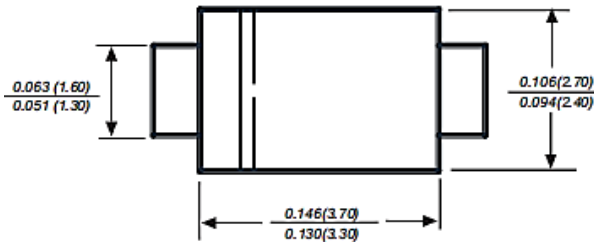
**DIMENSION (Unit: Inch/mm)**

Image for reference

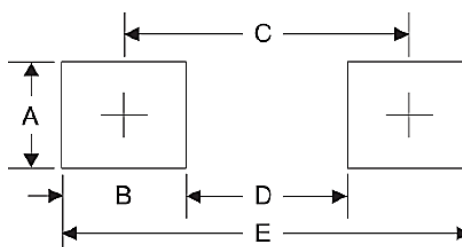


Marking: SS16F

SMAF



Recommend Pad Layout



Symbol	Unit (Inch)	Unit (mm)
A	0.071	1.80
B	0.063	1.60
C	0.150	3.80
D	0.087	2.21
E	0.213	5.40

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**SMD HIGH EFFICIENCY RECTIFIER SMAF SERIES**
**MECHANICAL DATA**

Case	Terminals	Polarity	Mounting Position	Weight per piece
JEDEC SMAF molded plastic body	Solder plated, Solderable per MIL-STD-750, Method 2026	Color band denotes cathode end	Any	0.00095 Ounce, 0.027 grams

**MAX. RATING & CHARACTERISTICS**

Parameter	SYMBOLS	VALUE			UNITS
		Min.	Typical	Max.	
<b>Repetitive peak reverse voltage</b>	V <sub>RRM</sub>			60	Volts
<b>RMS voltage</b>	V <sub>RMS</sub>			42	Volts
<b>DC blocking voltage</b>	V <sub>DC</sub>			60	Volts
<b>Average forward output rectified current at TL= 55°C</b>	I <sub>AV</sub>			1.0	A
<b>Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)</b>	I <sub>FSM</sub>		25		A
<b>Instantaneous forward voltage at 1.0A</b>	V <sub>F</sub>			0.70	Volts
<b>DC reverse current at rated DC blocking voltage</b>	I <sub>R</sub>	TA=25°C		0.3	mA
		TA=100°C		10.0	
<b>Junction capacitance (Note 3)</b>	C <sub>J</sub>		80		pF
<b>Thermal resistance (Note 4)</b>	R <sub>QJA</sub>		95		°C/W
<b>Operating junction temperature range</b>	T <sub>J</sub>	-55		+150	°C
<b>Storage temperature range</b>	T <sub>STG</sub>	-55		+150	°C

**Note**

1. Ratings at 25 C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.
2. Reverse recovery condition IF=0.5A,IR=1.0A,Irr=0.25A
3. Measured at 1.0MHz and applied reverse voltage of 4.0Voltage
4. P.C.B. mounted with 2.0x2.0"(5.0x5.0cm) copper pad areas.

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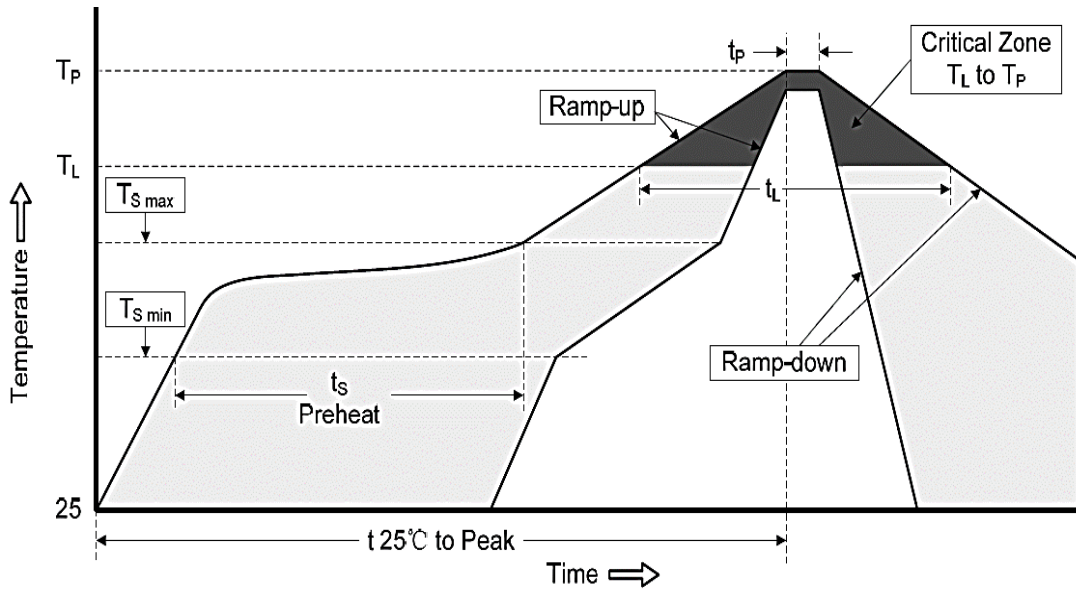
**SMD HIGH EFFICIENCY RECTIFIER SMAF SERIES**
**RELIABILITY**

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, TA=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

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**SUGGESTED REFLOW PROFILE (For Reference Only)**



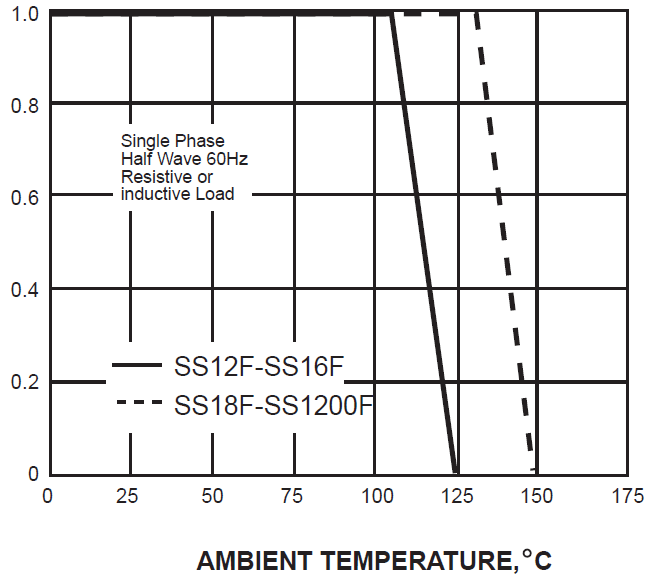
<b>Profile Feature</b>		Pb-Free Assembly
<b>Average Ramp-up Rate (Ts Max to Tp)</b>		3°C/second Max
<b>Preheat</b>	<b>Temperature Min (Ts Min.)</b>	150°C
	<b>Temperature Max (Ts Max.)</b>	200°C
	<b>Time (ts Min. to ts Max.)</b>	60 ~ 180 seconds
<b>Time maintained above</b>	<b>Temperature (Tl)</b>	217°C
	<b>Time (tl)</b>	60 ~ 150 seconds
<b>Peak/Classification Temperature (Tp)</b>		260 °C
<b>Time within 5°C of actual Peak Temperature (tp)</b>		20 ~ 40 seconds
<b>Ramp-down rate</b>		6 °C /Second Max.
<b>Time 25 °C to Peak Temperature</b>		8 minutes Max.
<b>Suggest reflow times</b>		3 Times Max.

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**RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**

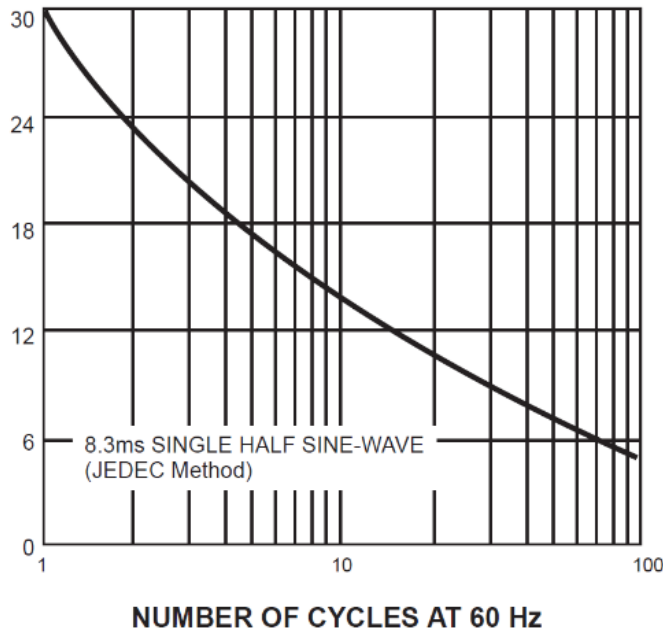
AVERAGE FORWARD RECTIFIED CURRENT, AMPERES

**FIG. 1- FORWARD CURRENT DERATING CURVE**



PEAK FORWARD SURGE CURRENT, AMPERES

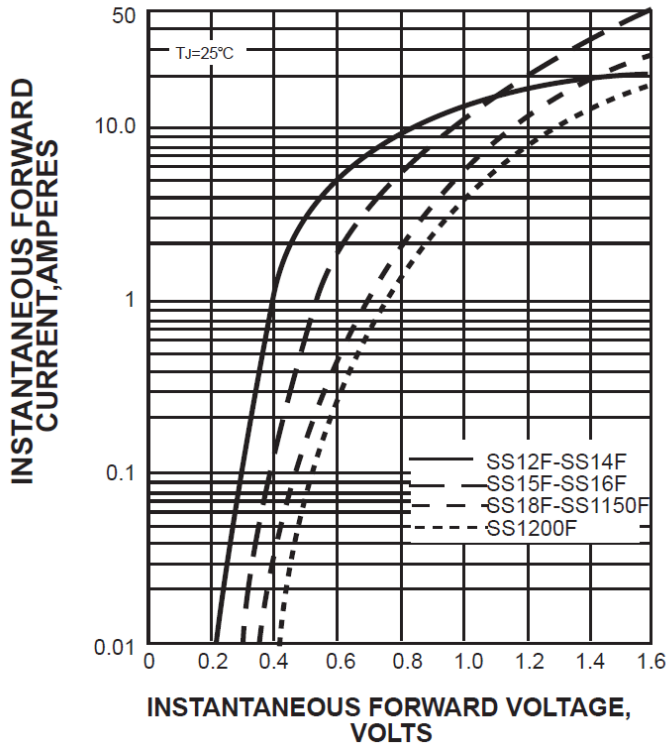
**FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT**



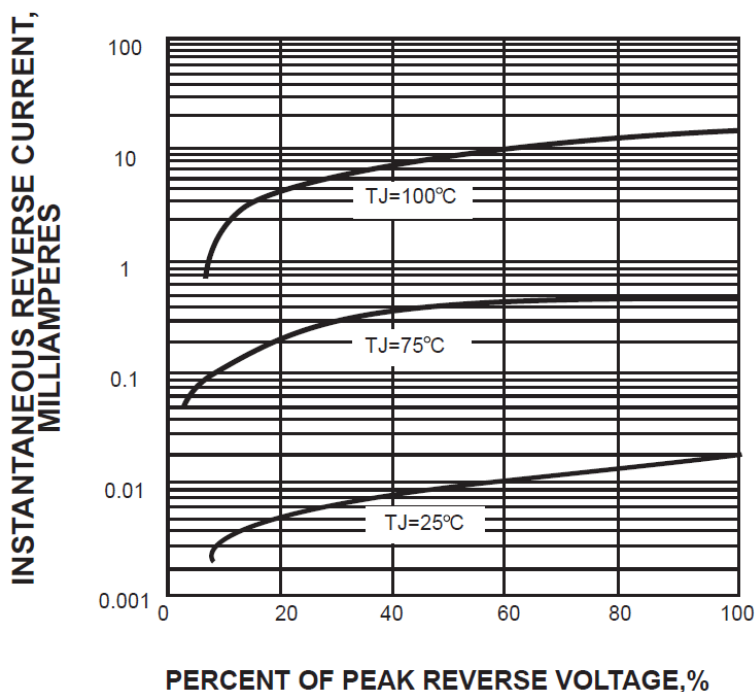
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**RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**

**FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS**



**FIG. 4-TYPICAL REVERSE CHARACTERISTICS**

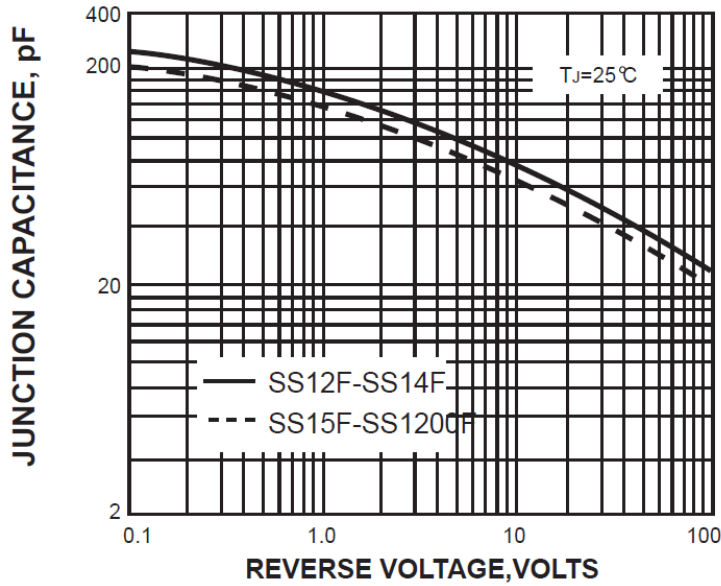




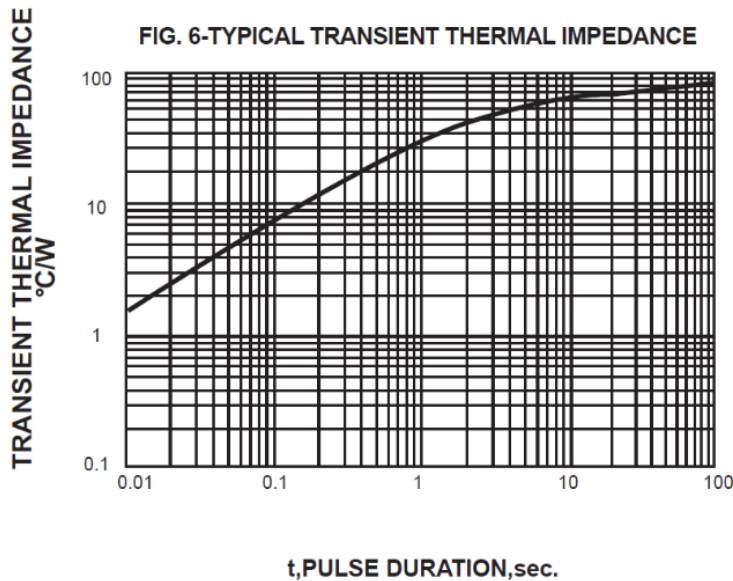
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**RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**

**FIG. 5-TYPICAL JUNCTION CAPACITANCE**



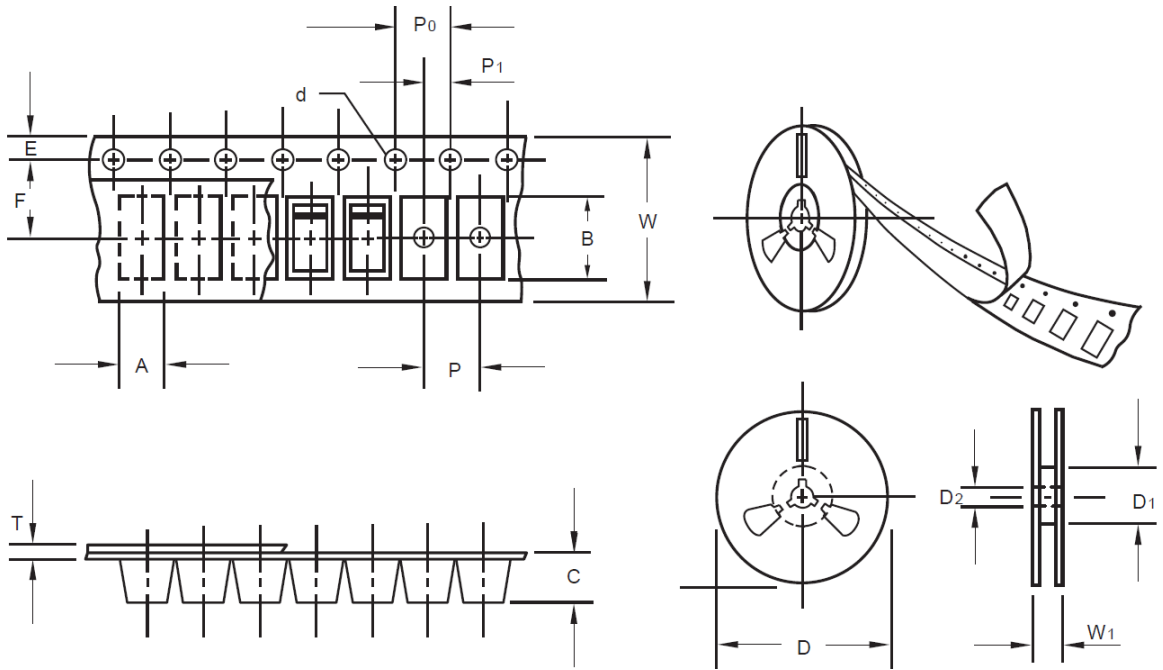
**FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE**



**SMD HIGH EFFICIENCY RECTIFIER SMAF SERIES**

**TAPE/REEL (Unit: mm)**

All Devices are packed in accordance with EIA standard RS-481-A and specifications.



Item	Symbol	Tolerance	SMAF
Carrier width	A	0.1	2.80
Carrier Length	B	0.1	4.75
Carrier Depth	C	0.1	1.42
Sprocket hole	d	0.05	1.50
7"Reel outside diameter	D	2.0	178.00
7"Reel inner diameter	D1	Min.	54.40
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.05
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.30
Tape width	W	0.3	8.00
Reel width	W1	1.0	12.30

**SMD HIGH EFFICIENCY RECTIFIER SMAF SERIES**

**PACKAGE For Reference**

Case Code	SMAF
Reel Size	7"
Reel Size	178 mm
MPQ/Reel	3000 pcs
Qty. /Box	6000 pcs
G.W/Box	1 lbs

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